

RF Power Amplifier & Programmable Synthesizer

Including: Basic Deflector Alignment

Instruction Manual RFA1170-4 + iMS4-L (revB)

Models -

RFA1170-4+iMS4-L : 50-90MHz, > 240W total RF output

CAUTION Models RFA1170-4 / LS700

DO NOT OPERATE WITHOUT LIQUID COOLING

* (Always refer to the AO test data sheet)

ISOMET CORP, 10342 Battleview Parkway, Manassas, VA 20109, USA. Tel: +1 703 321 8301, Fax: (703) 321 8546, e-mail: isomet@isomet.com www.ISOMET.com

ISOMET (UK) Ltd, 18 Llantarnam Park, Cwmbran, Torfaen, NP44 3AX, UK. Tel: +44 1633 872721, Fax: +44 1633 874678, e-mail: sales-uk@isomet.com



1. GENERAL

The Model RFA1170-4 is a class AB amplifier designed to drive the LS700- series of Isomet high power Germanium acousto-optic deflectors with up to 300Watts across a 40MHz bandwidth. When fitted with the iMS4-L synthesizer and controller cards, the RFA1170-4 power amplifier exhibits programmable phase shift and amplitude compensation capability across the four RF output channels.

This model is optimized for very fast rise and fall times and may be operated CW. (Always refer to the AO device data sheet).

The RFA1170-4 + iMS4-L combo includes a number of features to aid monitoring and control:

- Temperature monitoring and thermal Interlock for the Amplifier and associated AO deflector
- "Gate" control signal to enable RF amplifier (5V logic high = Active)
- External "Trigger" input, 3v3 LV-TTL compatible
- External "Clock" input, 3v3 LV-TTL compatible

Additional features are available under software control.

Please refer to the Isomet Software Development Kit available on-line.

A summary of the driver specification is shown in the following table:

<u>Model</u>	Use	Output	Phase Shifted	Output Power
	<u>with</u>	<u>Frequency</u>	Outputs	per Channel
RFA1170-4 + iMS4-L	LS700-1011	50 - 90MHz	Yes	> 80.0 Watt



Figure 2 shows a block diagram of the Driver.

The iMS4-L comprises two PCB's

Lower PCB features a four channel DDS and high speed FPGA with memory function.

Upper PCB is the main I/O interface and includes the USB II connection to the host

The -Enable signal is common to all four outputs. A closed contact between signal and ground will enable the RF power amplifier. No external pull-up is required and if a voltage is applied to this pin it must not exceed 3v3

The design includes thermal interlock protection which is also common to all four outputs

Each channel features a class A/B power stage to generate the final output level of up to 90W per output.

Water cooling is required. The heatsink temperature must not exceed 70°C.

- SERIOUS DAMAGE TO THE AMPLIFIER MAY RESULT IF THE TEMPERATURE EXCEEDS 70°C.
- SERIOUS DAMAGE TO THE AMPLIFIER MAY ALSO RESULT IF THE RF OUTPUT CONNECTOR IS OPERATED OPEN-CIRCUITED OR SHORT-CIRCUITED.
- SERIOUS DAMAGE TO THE AMPLIFIER WILL RESULT IF THE (FLOATING) INTERLOCK
 INPUT SIGNALS ARE CONNECTED TO CHASSIS GROUND OR 0V

A low impedance d-c power supply is required. The operating voltage is +24V at a current drain of approximately 32A. The external power supply should be capable of > 40A, with \pm 2% regulation and <200mV ripple voltage for best results.

Figure 1 shows the connections.



3. INSTALLATION AND ADJUSTMENT

- 3.1 For continuous or duty cycled operation above >2%, always connect cooling water.

 Flow rate greater than 2 litres / minute. Temperature < 20 degC

 (Factory fitted water connections suit 8mm OD plastic tubing).
- 3.2 Connect +24V DC to the screw terminals of the filtered DC connector. DO NOT APPLY POWER. The DC supply should be capable of 40A
- 3.2 Connect the (4) RF output TNC jacks to the (4) RF inputs of the acousto-optic deflector (or a 50Ω RF high power load). The connection order depends on the AO Bragg orientation (see Figure 4) and will be either 1→1, 2→2, 3→3, 4→4 or 1→4, 2→3, 3→2, 4→1. The deflector will not be damaged if the order is incorrect, but the efficiency will be non-uniform. The amplifier outputs must be terminated.

The cable lengths from the amplifier to the RF connections of the deflector must be equal.

3.4 Connect the <u>Interlock</u> of the acousto-optic deflector (7-way circular connector) to the 7-way connector J9 of the RFA1170/4. A suitable cable is supplied.

The interlock signal triggers a fault conditionif the temperature of the modulator or internal driver temperature exceeds 30°C. This will disable the RF outputs.

There are two LED indicators

- 1: The bulkhead LED (above RF output J2) is bi-colour.
 - RED indicates 24Vdc is ON but the thermal interlocks and/or -ENABLE signal are inactive.
 - Yellow indicates interlocks are OK and the -ENABLE signal is active.
 RF will be output as soon as the iMS4-L is programmed and initiated.
- 2: LED stack on the iMS4-Linterface PCB

A GREEN (or RED) LED will beat at 1Hz indicating that the interface control circuitry has initialized correctly

DO NOT connect any of the interlock signal wires to chassis ground or 0V.



- 3.5 Connect the USB to the host PC
- 3.6 Connect a voltage free contact to the -Enable SMA input.
- 3.7 Ensure the cooling water is on.
- 3.8 Apply + 24V DC to the amplifier.

(The external trigger and clock inputs are not required for basic operation, depending on the desired operating mode).

3.9 Adjustment of the RF output power is best done with amplifier connected to the acousto-optic modulator.

The optimum RF power level required for the modulator to produce maximum first order intensity will be different at various laser wavelengths. Applying RF power in excess of this optimum level will cause a decrease in first order intensity (a false indication of insufficient RF power) and makes accurate Bragg alignment difficult. It is therefore recommended that initial alignment be performed at a low RF power level.

3.10 RF power is adjusted under software control

Please refer to the iMS SDK available at http://www.isomet.com/software.html

3.11 Set the power to a mid-level e.g.

SDK Class Method description Setting
UpdateDDSPowerLevel 80%
UpdateRFAmplitude Wiper 40%

- 3.12 Program the DDS for a constant signal; Freq=70MHz, Ampl=100%, Phase=0 degree. This will operate the AO device at its mid-scan position.
- 3.13 Align the deflector head to insure that the incident light beam is centred in the active aperture of the deflector.



Observe the diffracted first-order output from the acousto-optic modulator and the undeflected zeroth order beam. Adjust the Bragg angle (rotate the deflector) to maximise first order beam intensity.

3.14 After Bragg angle has been optimized, slowly increase the RF power until maximum first order intensity is obtained. Record this intensity value (I_{SAT}).

Typical values:

SDK Class Method description	<u>Setting</u>
UpdateDDSPowerLevel	80%
UpdateRFAmplitude Wiper	60%

- 3.15 To equalise deflection efficiency across the extremes of the scan, alternate between the minimum and maximum desired frequencies (e.g. 50MHz and 90MHz input resp') and adjust the PHASE and AMPL values to give the same efficiency at both positions. Fine tuning of the incident Bragg angle and RF power may be necessary for optimum results.
- 3.15 The amplifier is now ready for use.

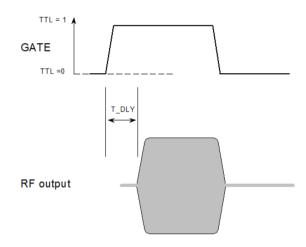
Please contact Isomet for further guidance and example programs



GATE Response

The GATE (active HIGH) should be applied 2msec prior to the required active RF output. The GATE may remain HIGH continuously. The RF amplifiers are design to be biased at 100% duty factor.

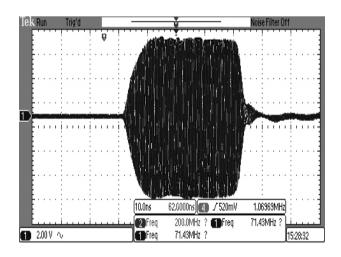
T_DLY = 1.8msec



Pulsed Response

All versions of the RA1170-4 are designed for fast pulse operation up to CW operation. Typical output RF waveform is shown below.

45W / 70MHz pulsed output 10%-90% rise / fall time = < 10nsec





4. MAINTENANCE

4.1 AO Device - Cleaning

It is of utmost importance that the optical apertures of the deflector optical head be kept clean and free of contamination. When the device is not in use, the apertures may be protected by a covering of masking tape. When in use, frequently clean the apertures with a pressurized jet of filtered, dry air.

It will probably be necessary in time to wipe the coated window surfaces of atmospherically deposited films. Although the coatings are hard and durable, care must be taken to avoid gouging of the surface and residue of the cleaning solution. It is suggested that the coatings be wiped with a soft ball of brushed (short fibres removed) cotton, slightly moistened with clean alcohol. Before the alcohol has had time to dry on the surface, wipe again with dry cotton in a smooth, continuous stroke. Examine the surface for residue and, if necessary, repeat the cleaning.

4.2 <u>Troubleshooting</u>

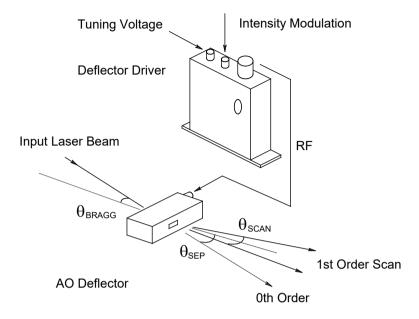
No troubleshooting procedures are proposed other than a check of alignment and operating procedure. If difficulties arise, take note of the symptoms and contact the manufacturer.

4.3 Repairs

In the event of deflector malfunction, discontinue operation and immediately contact the manufacturer or his representative. Due to the high sensitive of tuning procedures and the possible damage which may result, no user repairs are allowed. Evidence that an attempt has been made to open the optical head will void the manufacturer's warranty.



Schematic of Acousto-optic scanner and drive electronics.



The input Bragg angle, relative to a normal to the optical surface and in the plane of deflection is:

$$\theta_{\text{Bragg}} = \frac{\lambda.\text{fc}}{2.\text{V}}$$

The separation angle between the zeroth order and mid scan point of the first order is:

$$\theta \text{ sep} = \frac{\lambda.\text{fc}}{V}$$

The first order scan angle is:

$$\theta \text{ scan} = \frac{\lambda . \delta f}{V}$$

Modulation rate (Gaussian profile) is:

$$Tr = 0.65 \, d/v$$

Scanning Resolution is:

$$N = \delta f . d/v$$

where : λ = wavelength

 δ f = scan frequency bandwidth

fc = centre frequency

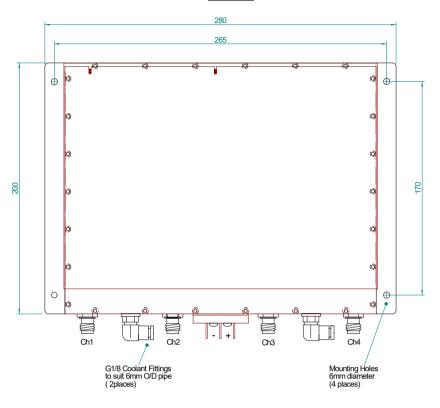
v = acoustic velocity of interaction material

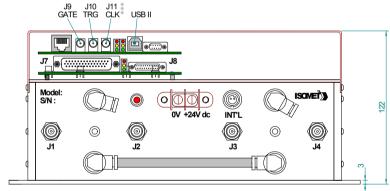
(5.5mm/us for Ge)

d = beam waist along acoustic axis



Outline





Connector Summary

J1:TNC, RF Output Ch1J2:TNC, RF Output Ch2J3:TNC, RF Output Ch3J4:TNC, RF Output Ch4

INT: 7-way Circular Panel Plug, Binder 712 (AOD Temp and isolated Interlock Input)

USB II: Host PC USB connection
J11 CLK: External data clock input
J10 TRG: External trigger input

J9 GATE: Connect a 5V logic high to enable amplifier.

J8 Auxiliary IO

J7 Synchronous IO logic

Figure 1: Driver Installation



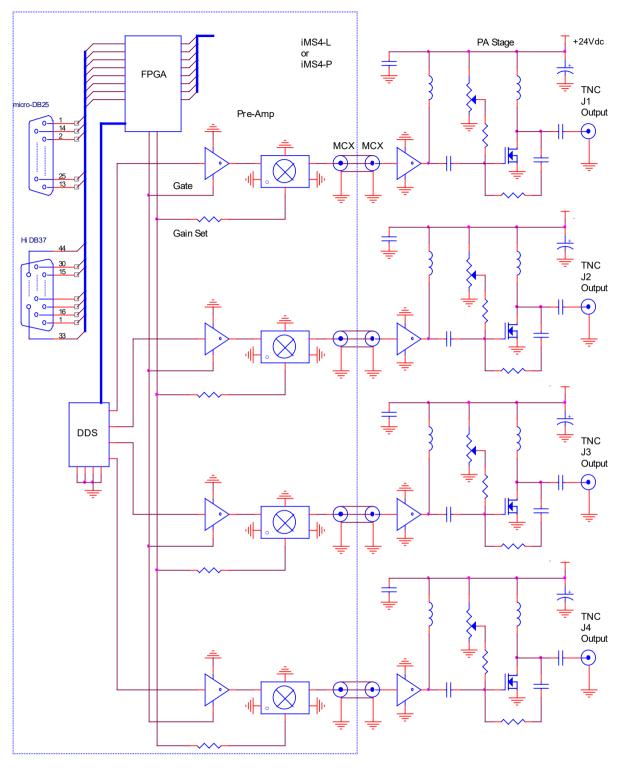


Figure 2: Driver Block Diagram



Signal	Connector	Spec	
GATE	SMA	LVTTL, 5V tolerant Logic low (or NC) = OFF, Logic high = ON	
J7/J8	HD D-types	Refer iMS4 manuals	
CLK	SMA	LVTTL, 5V tolerant Image Clock	
TRG	SMA	LVTTL, 5V tolerant Image Trigger	
USB	B-type	USBII	
INT	7-way Binder	Connect to AO device (cable supplied)	
Vdc	Screw terminal	24Vdc, 40A	

LED indicators:

1: The bulkhead dual colour LED fitted above RF output J2

RED indicates:

24Vdc is ON, but a fault condition exists;

AOD or RFA Over Temperature Interlock failure
GATE signal is inactive (open or 0V)

AMPLIFIER_ENABLE is not enabled in the software control

YELLOW indicates amplifier is enabled and the RF outputs are live

2: LED traffic light stacks on the iMS4-L synthesizer

GREEN LEDs will beat at 1Hz indicating that the interface control circuitry has initialized correctly. See iMS4-L manual for full description.

Figure 3: Signal listing



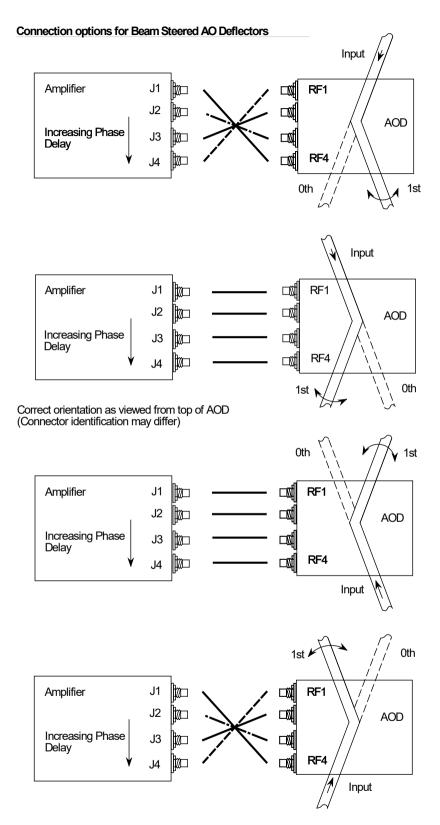


Figure 4: Connection Orientation.

(Assumes the relative phase offset across the four iMS4-L outputs are programmed accordingly)